



# RECORDATION FORM COVER SHEET PATENTS ONLY

102773046

Patents: Please record the attached original document(s) or copy(ies) thereof.

1. Name of Conveying Party(ies):  
Yukitaka Tanaka

Additional name(s) of conveying party(ies) attached?

☐ Yes☒ No

2. Name and Address of Party(ies) receiving an interest (assignee(s)):

Name: Japan Aviation Electronics Industry, Limited

Address: 21-2 Dogenzaka 1-chome,  
Shibuya-ku,

Country: Tokyo, JAPAN

Additional name(s) and address(es) attached?

☐ Yes☒ No

3. Nature of Conveyance:

☒ Assignment☐ Merger☐ Change of Name☐ Verified Translation☐ Security Agreement☐ Other: \_\_\_\_\_Execution Date: **January 19, 2004**

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date(s) of the application is: \_\_\_\_\_

A. Patent Application No(s):**29/197,928**B. Patent No(s):

Others on additional sheet(s) attached?

☐ Yes☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

**24735**

6. Total number of applications and patents involved:

Application(s): 1+ Patent(s): 0= Total: 1

7. Total Fee (37 C.F.R. § 3.41) . . . . \$ **40.00**

☒ Enclosed☐ Authorized to be charged to Deposit Account

8. Deposit Account No.: **02-0375**

(Duplicate copy of this sheet attached)

☒ Charge any underpayment or credit any overpayment to above Deposit Account

DO NOT USE THIS SPACE

9. Statement and Signature

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

**James B. Arpin**

Name of Person Signing

Signature

**06/17/04**

Date

Total number of pages including cover sheet, attachments, and document:

06/21/2004 ECDOPER 00000079 29197928

01 FC:8021

40.00 OP

3

## ASSIGNMENT

WHEREAS, I, YUKITAKA TANAKA, a citizen of Japan, have invented certain new, original, and ornamental designs for:

### ELECTRICAL CONNECTOR

described in an application for United States Letters Patent executed on January 19, 2004 filed on January 23, 2004 and accorded Application No. 29/197,928;

AND, WHEREAS, Japan Aviation Electronics Industry, Limited, a corporation organized under the laws of Japan, located at 21-2, Dogenzaka 1-chome, Shibuya-ku, Tokyo, Japan, (hereinafter "ASSIGNEE"), is desirous of acquiring certain rights thereunder and in and to said designs;

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration, receipt of which is hereby acknowledged, I, do hereby sell, assign and transfer unto said ASSIGNEE, its successors, assigns and legal representatives, my entire right, title and interest in and throughout the United States of America (including its territories and dependencies) in and to said designs, said United States application, any other United States patent applications, including provisional, divisional, renewal, substitute, continuation, reexamination, and reissue applications, based in whole or in part on said United States patent application or in whole or in part on said designs, and in and to any and all letters patent, including extensions thereof, which have been or may be granted on any of the aforesaid applications or on said designs or any parts thereof;

AND I hereby agree for myself and my heirs, executors and administrators to execute without further consideration any further documents and instruments which may be necessary, lawful and proper in the prosecution of said above-referenced application or in the preparation or prosecution of any continuing, substitute, divisional, renewal, reexamination or reissue application or in any amendments, extensions or interference proceedings, that may be necessary to secure to ASSIGNEE its interest and title in and to said designs or any parts thereof, and in and to said several patents or any of them;

AND I hereby authorize and request our attorneys, Baker Botts L.L.P., whose address is The Warner, Suite 1300, 1299 Pennsylvania Avenue, N.W., Washington, D.C. 20004-2400, to insert above, the filing date and application number of said application when known.

AND I hereby covenant for myself and my legal representatives, and agree with said ASSIGNEE, its successors and assigns, that I have granted no right or license to make, use or sell said designs, to anyone except said ASSIGNEE, that prior to the execution of this deed, my right, title and interest in said designs had not been otherwise encumbered, and that I have not and will not execute any instrument in conflict therewith;

AND I do hereby authorize and request the Director of the United States Patent and Trademark Office to issue any and all letters patent which may be granted upon said United

States patent applications, or upon said designs or any parts thereof when granted, to said ASSIGNEE.

IN WITNESS WHEREOF, I have hereunto set my hand and seal.

January 19, 2004  
Date

Yukitaka Tanaka  
Inventor's Name YUKITAKA TANAKA

WITNESSES:

Masako Nagaijumi

Tamotou Tsuchiya

BAKER BOTTS L.L.P.  
THE WARNER, SUITE 1300  
1299 PENNSYLVANIA AVENUE, N.W.  
WASHINGTON, D.C. 20004-2400  
(202) 639-7700 (TELEPHONE)  
(202) 639-7890 (FACSIMILE)